

54F/74F646 • 74F646B • 54F/74F648 Octal Transceiver/Register with TRI-STATE® Outputs

General Description

These devices consist of bus transceiver circuits with TRI-STATE, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes to a high logic level. Control \bar{G} and direction pins are provided to control the transceiver function. In the transceiver mode, data present at the high impedance port may be stored in either the A or the B register or in both. The select controls can multiplex stored and real-time (transparent mode) data. The direction control determines which bus will receive data when the enable control \bar{G} is Active LOW. In the isolation mode (control \bar{G} HIGH), A data may be stored in the B register and/or B data may be stored in the A register.

Features

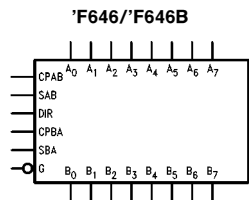
- Independent registers for A and B buses
- Multiplexed real-time and stored data
- 'F648 has inverting data paths
- 'F646/'F646B have non-inverting data paths
- 'F646B is a faster version of the 'F646
- TRI-STATE outputs
- 300 mil slim DIP
- Guaranteed 4000V minimum ESD protection

Commercial	Military	Package Number	Package Description
74F646SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
	54F646DM (Note 2)	J24F	24-Lead (0.300" Wide) Ceramic Dual-In-Line
74F646SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
74F646MSA (Note 1)		MSA24	24-Lead Molded Shrink Small Outline, EIAJ, Type II
	54F646FM (Note 2)	W24C	24-Lead Cerpack
	54F646LM (Note 2)	E28A	28-Lead Ceramic Leadless Chip Carrier, Type C
74F646BSPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
74F646BSC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
74F648SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
	54F648SDM (Note 2)	J24F	24-Lead (0.300" Wide) Ceramic Dual-In-Line
74F648SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
	54F648FM (Note 2)	W24C	24-Lead Cerpack
	54F648LM (Note 2)	E28A	24-Lead Ceramic Leadless Chip Carrier, Type C

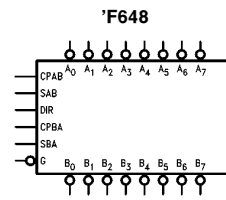
Note 1: Devices also available in 13" reel. Use suffix = SCX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

Logic Symbols



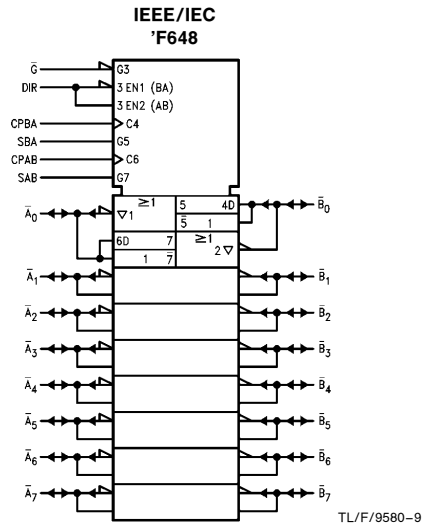
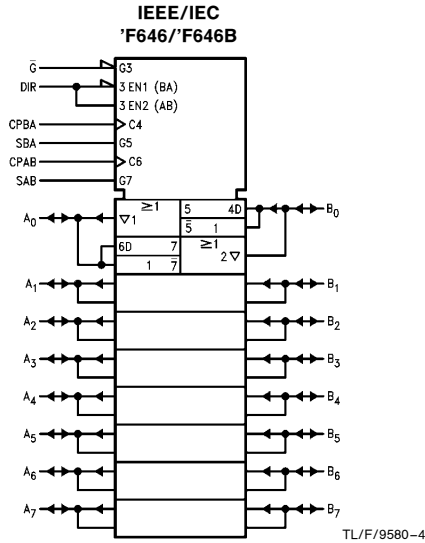
TL/F/9580-1



TL/F/9580-7

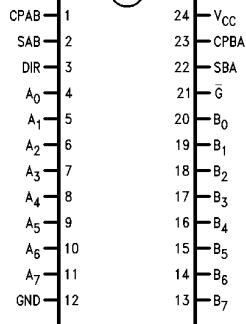
TRI-STATE® is a registered trademark of National Semiconductor Corporation.

Logic Symbols (Continued)

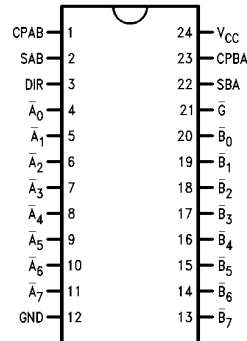


Connection Diagrams

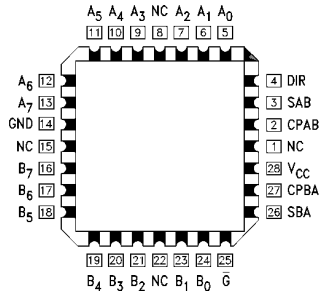
**Pin Assignment
for DIP, SOIC and Flatpak
'F646/'F646B**



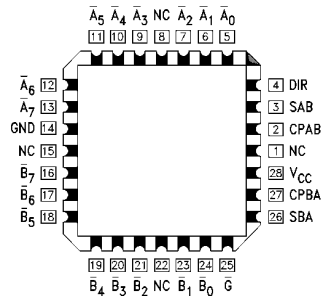
**Pin Assignment
for DIP, SOIC and Flatpak
'F648**



**Pin Assignment
for LCC
'F646/'F646B**









**Pin Assignment
for LCC
'F648**




Unit Loading/Fan Out

Pin Names	Description	54F/74F	
		U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
A ₀ –A ₇	Data Register A Inputs/ TRI-STATE Outputs	3.5/1.083 600/106.6 (80)	70 μ A / –650 μ A –12 mA/64 mA (48 mA)
B ₀ –B ₇	Data Register B Inputs/ TRI-STATE Outputs	3.5/1.083 600/106.6 (80)	70 μ A / –650 μ A –12 mA/64 mA (48 mA)
CPAB, CPBA	Clock Pulse Inputs	1.0/1.0	20 μ A / –0.6 mA
SAB, SBA	Select Inputs	1.0/1.0	20 μ A / –0.6 mA
\bar{G}	Output Enable Input	1.0/1.0	20 μ A / –0.6 mA
DIR	Direction Control Input	1.0/1.0	20 μ A / –0.6 mA

Function Table

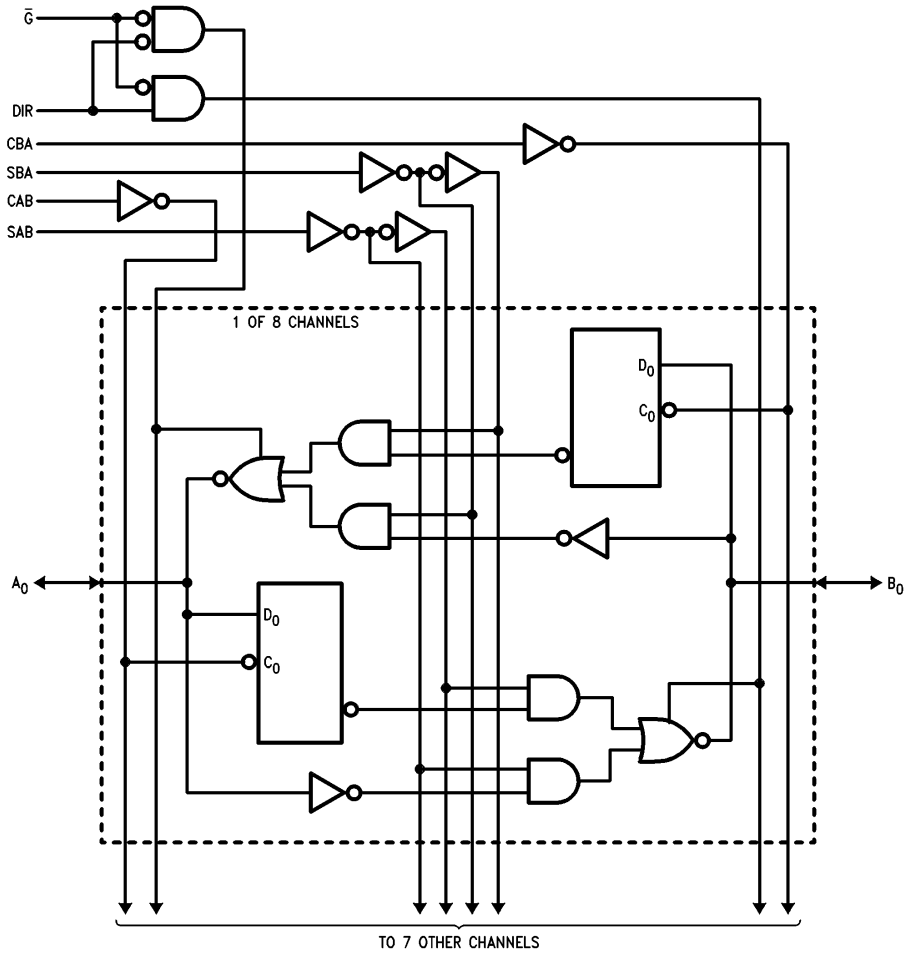
Inputs						Data I/O*		Function
\bar{G}	DIR	CPAB	CPBA	SAB	SBA	A ₀ –A ₇	B ₀ –B ₇	
H	X	H or L	H or L	X	X	Input	Input	Isolation
H	X		X	X	X			Clock A _n Data into A Register
H	X	X		X	X			Clock B _n Data into B Register
L	H	X	X	L	X	Input	Output	A _n to B _n —Real Time (Transparent Mode)
L	H		X	L	X			Clock A _n Data into A Register
L	H	H or L	X	H	X			A Register to B _n (Stored Mode)
L	H		X	H	X			Clock A _n Data into A Register and Output to B _n
L	L	X	X	X	L	Output	Input	B _n to A _n —Real Time (Transparent Mode)
L	L	X		X	L			Clock B _n Data into B Register
L	L	X	H or L	X	H			B Register to A _n (Stored Mode)
L	L	X		X	H			Clock B _n Data into B Register and Output to A _n

*The data output functions may be enabled or disabled by various signals at the \bar{G} and DIR Inputs. Data input functions are always enabled; i.e., data at the bus pins will be stored on every LOW-to-HIGH transition of the clock inputs.

H = HIGH Voltage Level
L = LOW Voltage Level
X = Irrelevant
 = LOW-to-HIGH Transition

Logic Diagrams (Continued)

'F646/'F646B

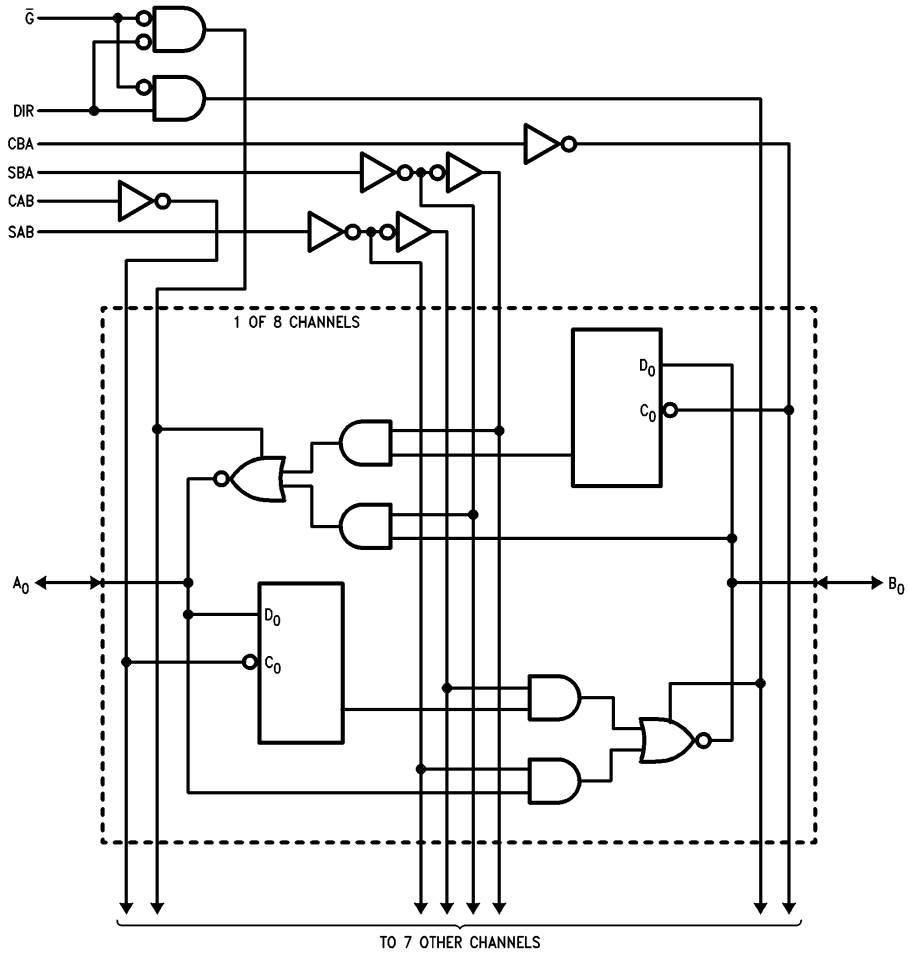


TL/F/9580-5

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Logic Diagrams (Continued)

'F648



TL/F/9580-6

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	–65°C to +150°C
Ambient Temperature under Bias	–55°C to +125°C
Junction Temperature under Bias	–55°C to +175°C
Plastic	–55°C to +150°C

V_{CC} Pin Potential to Ground Pin –0.5V to +7.0V

Input Voltage (Note 2) –0.5V to +7.0V

Input Current (Note 2) –30 mA to +5.0 mA

Voltage Applied to Output in HIGH State (with V_{CC} = 0V)

Standard Output	–0.5V to V _{CC}
TRI-STATE Output	–0.5V to +5.5V

Current Applied to Output in LOW State (Max) twice the rated I_{OL} (mA)

ESD Last Passing Voltage (Min) 4000V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature	
Military	–55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

DC Electrical Characteristics

Symbol	Parameter	54F/74F			Units	V _{CC}	Conditions
		Min	Typ	Max			
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage				V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage				V	Min	I _{IN} = –18 mA (Non I/O Pins)
V _{OH}	Output HIGH Voltage	54F 10% V _{CC}	2.0		V	Min	I _{OH} = –12 mA (A _n , B _n) I _{OH} = –15 mA (A _n , B _n)
		74F 10% V _{CC}	2.0				
V _{OL}	Output LOW Voltage	54F 10% V _{CC}	0.55		V	Min	I _{OL} = 48 mA (A _n , B _n) I _{OL} = 64 mA (A _n , B _n)
		74F 10% V _{CC}	0.55				
I _{IH}	Input HIGH Current	54F	20.0		μA	Max	V _{IN} = 2.7V (Non I/O Pins)
		74F	5.0				
I _{BVI}	Input HIGH Current Breakdown Test	54F	100		μA	Max	V _{IN} = 7.0V (Non I/O Pins)
		74F	7.0				
I _{BVIT}	Input HIGH Current Breakdown (I/O)	54F	1.0		mA	Max	V _{IN} = 5.5V (A _n , B _n)
		74F	0.5				
I _{CEX}	Output HIGH Leakage Current	54F	250		μA	Max	V _{OUT} = V _{CC}
		74F	50				
V _{ID}	Input Leakage Test	74F	4.75		V	0.0	I _{ID} = 1.9 μA All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current	74F	3.75		μA	0.0	V _{IOD} = 150 mV All Other Pins Grounded
I _{IL}	Input LOW Current				mA	Max	V _{IN} = 0.5V (Non I/O Pins)
I _{IH} + I _{OZH}	Output Leakage Current				μA	Max	V _{OUT} = 2.7V (A _n , B _n)
I _{IL} + I _{OZL}	Output Leakage Current				μA	Max	V _{OUT} = 0.5V (A _n , B _n)
I _{OS}	Output Short-Circuit Current	–100	–225		mA	Max	V _{OUT} = 0V
I _{ZZ}	Bus Drainage Test				μA	0.0V	V _{OUT} = 5.25V
I _{CCH}	Power Supply Current				mA	Max	V _O = HIGH
I _{CCL}	Power Supply Current				mA	Max	V _O = LOW
I _{CCZ}	Power Supply Current				mA	Max	V _O = HIGH Z

'F646/'F648

AC Electrical Characteristics

Symbol	Parameter	74F		54F		74F		Units
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$ $C_L = 50\text{ pF}$		$T_A, V_{CC} = \text{Mil}$ $C_L = 50\text{ pF}$		$T_A, V_{CC} = \text{Com}$ $C_L = 50\text{ pF}$		
		Min	Max	Min	Max	Min	Max	
f_{max}	Maximum Clock Frequency	90		75		90		MHz
t_{PLH} t_{PHL}	Propagation Delay Clock to Bus	2.0	7.0	2.0	8.5	2.0	8.0	ns
t_{PLH} t_{PHL}	Propagation Delay Bus to Bus ('F646)	1.0	7.0	1.0	8.0	1.0	7.5	ns
t_{PLH} t_{PHL}	Propagation Delay Bus to Bus ('F648)	2.0	8.5	1.0	10.0	2.0	9.0	ns
t_{PLH} t_{PHL}	Propagation Delay SBA or SAB to A or B	2.0	8.5	2.0	11.0	2.0	9.5	ns
t_{PZH} t_{PZL}	Enable Time $\overline{\text{OE}}$ to A or B	2.0	8.5	2.0	10.0	2.0	9.0	ns
t_{PHZ} t_{PLZ}	Disable Time $\overline{\text{OE}}$ to A or B	1.0	7.5	1.0	9.0	1.0	8.5	ns
t_{PZH} t_{PZL}	Enable Time DIR to A or B	2.0	14.0	2.0	16.0	2.0	15.0	ns
t_{PHZ} t_{PLZ}	Disable Time DIR to A or B	1.0	9.0	1.0	10.0	1.0	9.5	ns

'F646/'F648

AC Operating Requirements

Symbol	Parameter	74F		54F		74F		Units
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$		$T_A, V_{CC} = \text{Mil}$		$T_A, V_{CC} = \text{Com}$		
		Min	Max	Min	Max	Min	Max	
$t_{\text{s(H)}}$ $t_{\text{s(L)}}$	Setup Time, HIGH or LOW Bus to Clock	5.0		5.0		5.0		ns
$t_{\text{h(H)}}$ $t_{\text{h(L)}}$	Hold Time, HIGH or LOW Bus to Clock	2.0		2.5		2.0		ns
$t_{\text{w(H)}}$ $t_{\text{w(L)}}$	Clock Pulse Width HIGH or LOW	5.0		5.0		5.0		ns

'F646B

AC Electrical Characteristics

Symbol	Parameter	74F		54F		74F		Units
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$ $C_L = 50\text{pF}$		$T_A, V_{CC} = \text{Mil}$ $C_L = 50\text{pF}$		$T_A, V_{CC} = \text{Com}$ $C_L = 50\text{pF}$		
		Min	Max	Min	Max	Min	Max	
f_{max}	Maximum Clock Frequency	165				150		MHz
t_{PLH} t_{PHL}	Propagation Delay Clock to Bus	2.5	7.0			2.5	8.0	ns
t_{PLH} t_{PHL}	Propagation Delay Bus to Bus	2.0	6.0			2.0	7.0	ns
t_{PLH} t_{PHL}	Propagation Delay SBA or SAB to A or B	2.5	7.5			2.5	8.5	ns
t_{PZH} t_{PZL}	Enable Time $\overline{\text{OE}}$ to A or B	2.5	6.5			2.5	8.0	ns
t_{PHZ} t_{PLZ}	Disable Time $\overline{\text{OE}}$ to A or B	1.5	6.5			1.5	7.5	ns
t_{PZH} t_{PZL}	Enable Time DIR to A or B	2.0	7.0			2.0	8.5	ns
t_{PHZ} t_{PLZ}	Disable Time DIR to A or B	1.5	7.5			1.5	8.5	ns

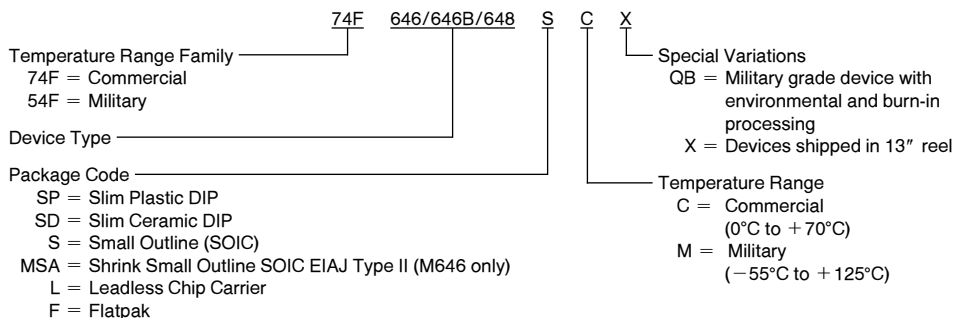
'F646B

AC Operating Requirements

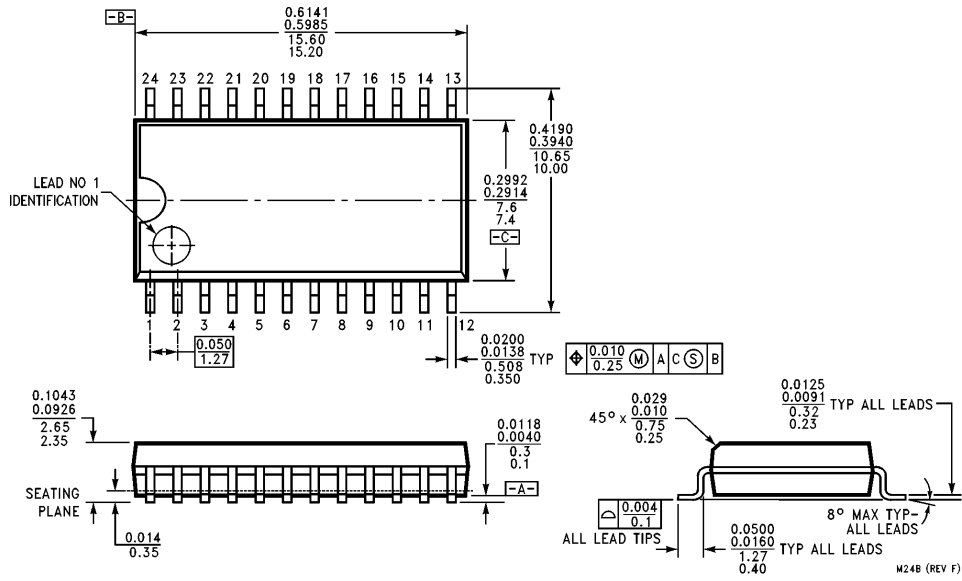
Symbol	Parameter	74F		54F		74F		Units
		$T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{V}$		$T_A, V_{CC} = \text{Mil}$		$T_A, V_{CC} = \text{Com}$		
		Min	Max	Min	Max	Min	Max	
$t_s(\text{H})$ $t_s(\text{L})$	Setup Time, HIGH or LOW Bus to Clock	5.0				4.0		ns
$t_h(\text{H})$ $t_h(\text{L})$	Hold Time, HIGH or LOW Bus to Clock	1.5				1.5		ns
$t_w(\text{H})$ $t_w(\text{L})$	Clock Pulse Width HIGH or LOW	5.0				5.0		ns

Ordering Information

The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:

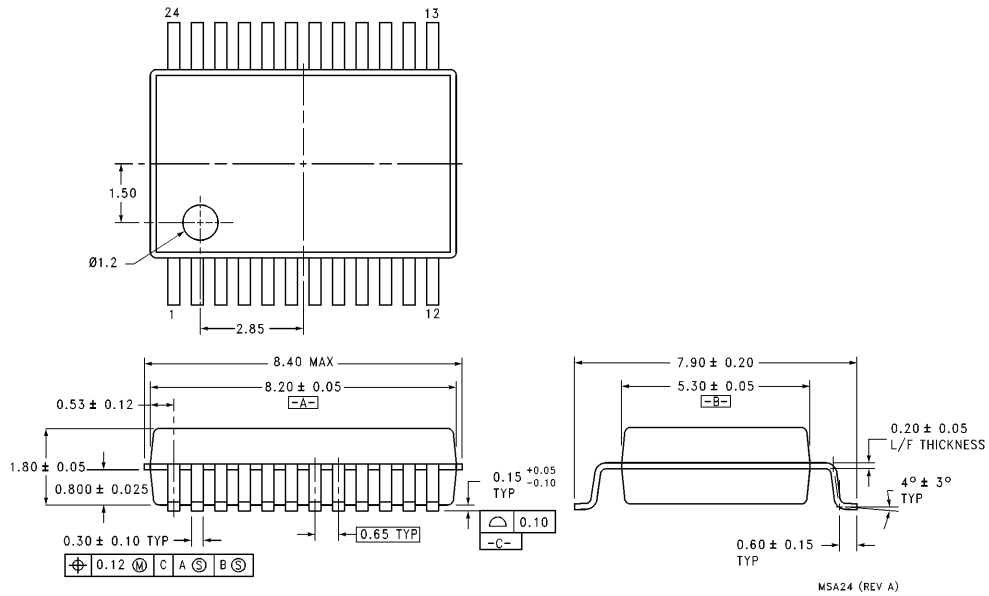


Physical Dimensions inches (millimeters) (Continued)

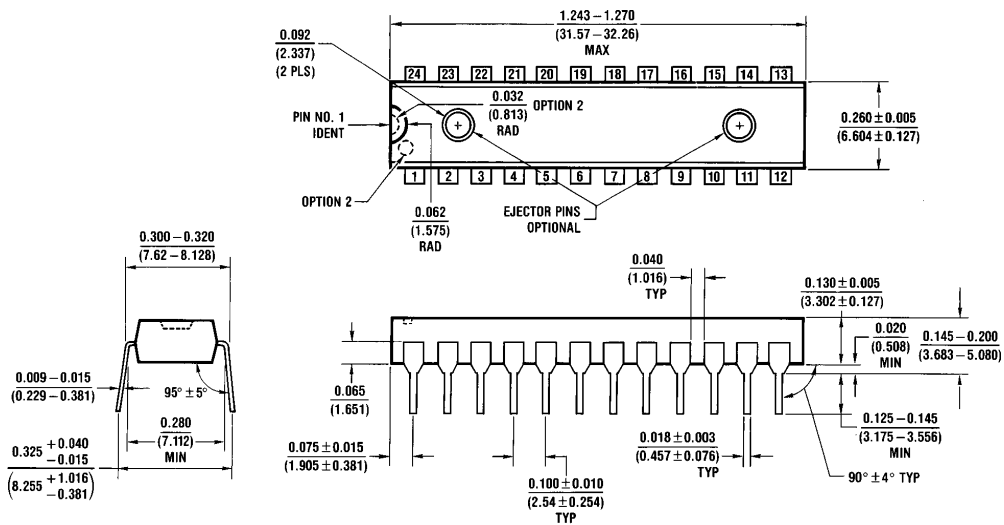


**24-Lead (0.300" Wide) Molded Small Outline Package, JEDEC (S)
NS Package Number M24B**

Physical Dimensions inches (millimeters) (Continued)

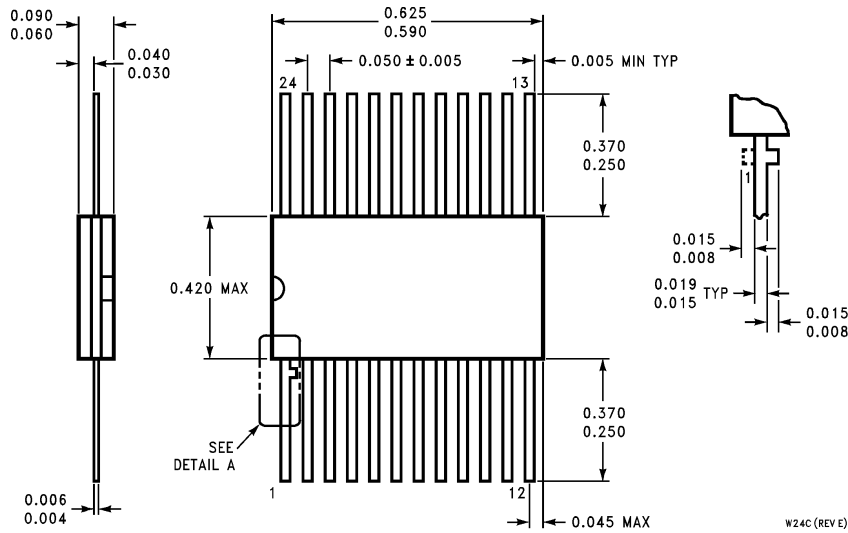


24-Lead Molded Shrink Small Outline Package, EIAJ, Type II
NS Package Number MSA24



24-Lead (0.300" Wide) Molded Dual-In-Line Package (SP)
NS Package Number N24C

Physical Dimensions inches (millimeters) (Continued)



**24-Lead Cerpack
NS Package Number W24C**

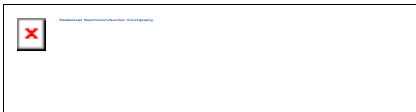
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Features


- Independent registers for A and B buses
- Multiplexed real-time and stored data
- 'F648 has inverting data paths
- 'F646/'F646B have non-inverting data paths
- 'F646B is a faster version of the 'F646
- TRI-STATE outputs
- 300 mil slim DIP
- Guaranteed 4000V minimum ESD protection


Datasheet

Title	Size (in Kbytes)	Date	 View Online	 Download	 Receive via Email
54F646/54F648 Octal Transceiver/Register with TRI-STATE(RM) Outputs	202 Kbytes	9-Dec-97	View Online	Download	Receive via Email

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Package Availability, Models, Samples & Pricing

Part Number	Package		Status	Models		Samples & Electronic Orders	Budgetary Pricing		Std Pack Size	Package Marking
	Type	# pins		SPICE	IBIS		Quantity	\$US each		
5962-89754013A	LCC	28	Full production	N/A	N/A		50+	\$17.7000	tray of 25	[logo]çZçSç4çA 54F646 LMQB /QçM\$E 5962- 89754013A
5962-8975401LA	Cerdip	24	Full production	N/A	N/A	.	50+	\$13.0000	tube of 15	[logo]çZçSç4çA\$E 54F646SDMQB /QçM 5962-8975401LA

5962-8975401KA	Cerpack	24	Full production	N/A	N/A		50+	\$16.0000	tube of 19	[logo]ZS4A\$E 54F646FMQB QM 5962- 8975401KA
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[Information as of 1-Sep-2000]

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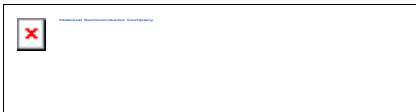
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
General Description

These devices consist of bus transceiver circuits with TRI-STATE, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus will be clocked into the registers as the appropriate clock pin goes to a high logic level. Control G# and direction pins are provided to control the transceiver function. In the transceiver mode, data present at the high impedance port may be stored in either the A or the B register or in both. The select controls can multiplex stored and real-time (transparent mode) data. The direction control determines which bus will receive data when the enable control G# is Active LOW. In the isolation mode (control G# HIGH), A data may be stored in the B register and/or B data may be stored in the A register.

Features


- Independent registers for A and B buses
- Multiplexed real-time and stored data
- 'F648 has inverting data paths
- 'F646/'F646B have non-inverting data paths
- 'F646B is a faster version of the 'F646
- TRI-STATE outputs
- 300 mil slim DIP
- Guaranteed 4000V minimum ESD protection

Datasheet

Title	Size (in Kbytes)	Date	 View Online	 Download	 Receive via Email
54F646/54F648 Octal Transceiver/Register with TRI-STATE(RM) Outputs	202 Kbytes	9-Dec-97	View Online	Download	Receive via Email

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Package Availability, Models, Samples & Pricing

Part Number	Package		Status	Models		Samples & Electronic Orders	Budgetary Pricing		Std Pack Size	Package Marking
	Type	# pins		SPICE	IBIS		Quantity	\$US each		
5962-8975402LA	Cerdip	24	Full production	N/A	N/A		50+	\$12.9000	tube of 15	[logo]cZcSç4çA\$E 54F648SDMQB /QçM 5962-8975402LA

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